TECHNICAL DATA

POLYIMIDE FILM TAPE FOR PRINTED CIRCUIT BOARD ASSEMBLY Product Code: 1KPCB

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- Description : 1KPCB a high temperature polyimide film coated with <u>Silicone</u> adhesive, is readily removable from a PCB surface after the reflow process without causing any adhesive residue making it the ideal choice for gold finger masking application.
- Application : For use in printed circuit board assembly for a wave solder masking tape; gold finger masking on PC boards during wave soldering process and during hot air level.

Technical Details :	PROPERTIES	<u>UNITS</u>	SPECIFICATION
	COLOR	-	amber
	TOTAL THICKNESS	mm	0.068 ± 0.005
	TENSILE STRENGTH	N/25mm	100
	ELONGATION	%	35
	ADHESION STRENGTH	N/25mm	6.5
	TEMPERATURE OPERATION	°C	280 (Short time)
Test Method :	In accordance with <u>ASTM D-1000</u> method		
Shelf Life :	6 months when storage at 23°C and 65% relative humidity		

Availability : Standard 33M roll 3" core, width 500mm



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